Electronic Patent	App	lication Fee	Transm	ittal			
Application Number:	10	10786807					
Filing Date:	25-	25-Feb-2004					
Title of Invention:	Ме	Method for improving semiconductor wafer test accuracy					
First Named Inventor/Applicant Name:	Hu	Hui-Mei Chen					
Filer:	De	Dennis Alan Duchene/Tobi Terry					
Attorney Docket Number:	08	085027-0106					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:					I		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	130	130		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			130